

74LCX07

Low-voltage CMOS hex buffer (open drain) with 5 V tolerant inputs

Datasheet -production data

Features

- 5 V tolerant inputs
- High speed
 - t_{PD} = 5.2 ns (max.) at V_{CC} = 3 V
- Power-down protection on inputs and outputs
- Symmetrical output impedance
 II_{OH}I = I_{OL} = 24 mA (min.) at V_{CC} = 3 V
- PCI bus levels guaranteed at 24 mA
- Operating voltage range
 - V_{CC} (opr.) = 2.0 V to 3.6 V
- Pin and function compatible with 74 series 07
- Latch-up performance exceeds 500 mA (JESD 17)

Device summary

- ESD performance
 - HBM: 2000 V (MIL STD 883 method 3015)
 - MM: 200 V
 - CDM: 1000 V

Applications

- Automotive
- Industrial
- Computer
- Consumer

Table 1.

TSSOP14 SO-14

Description

The 74LCX07 device is a low-voltage CMOS open drain hex buffer manufactured with submicron silicon gate and double-layer metal wiring C^2 MOS technology. It is ideal for low-power and high-speed 3.3 V applications and can be interfaced to a 5 V signal environment for inputs.

The internal circuit is composed of 2 stages including a buffer output, which provides high noise immunity and stable output.

It has the same speed performance at 3.3 V as the 5 V AC/ACT family, combined with lower power consumption.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2 kV ESD immunity and transient excess voltage.

Order code	Temperature range	Package	Packaging	Marking
74LCX07TTR	-40/+85 °C	TSSOP14	Tape and reel	LCX07
74LCX07YTTR ⁽¹⁾	-40/+85 °C	TSSOP14 (automotive grade)	Tape and reel	LCX07Y
74LCX07MTR	-40/+85 °C	SO-14	Tape and reel	74LCX07
74LCX07YMTR ⁽¹⁾	-40/+85 °C	SO-14 (automotive grade)	Tape and reel	74LCX07Y

1. Qualification and characterization according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 and Q002 or equivalent.

This is information on a product in full production.

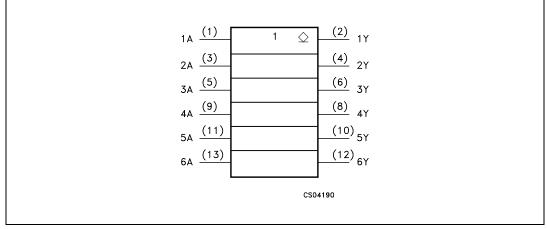
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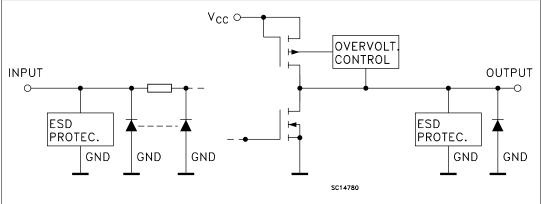


1 Logic symbols and I/O equivalent circuit







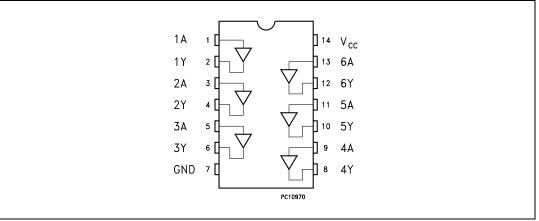




2 Pin settings

2.1 Pin connections

Figure 3. Pin connections (top through view)



2.2 Pin description

Table 2. Pin description

Pin number	Symbol	Name and function
1, 3, 5, 9, 11, 13	1A to 6A	Data inputs
2, 4, 6, 8, 10, 12	1Y to 6Y	Data outputs
7	GND	Ground (0 V)
14	V _{CC}	Positive supply voltage

2.3 Truth table

Table 3. Truth table

Input	Output
А	Y
L	L
н	Z ⁽¹⁾

1. High impedance.



3 Maximum ratings

Stressing the device above the rating listed in *Table 4: Absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in *Table 5: Recommended operating conditions* of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to +7.0	V
VI	DC input voltage	-0.5 to +7.0	V
Vo	DC output voltage (V _{CC} = 0 V)	-0.5 to +7.0	V
Vo	DC output voltage (high or low state) ⁽¹⁾	-0.5 to V _{CC} + 0.5	V
I _{IK}	DC input diode current	-50	mA
I _{OK}	DC output diode current ⁽²⁾	-50	mA
Ι _Ο	DC output current	±50	mA
I _{CC}	DC supply current per supply pin	±100	mA
I _{GND}	DC ground current per supply pin	±100	mA
T _{stg}	Storage temperature	-65 to +150	°C
TL	Lead temperature (10 sec.)	300	°C

Table 4. Absolute maximum ratings

1. I_O absolute maximum rating must be observed.

2. V_O < GND.

Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage ⁽¹⁾	2.0 to 3.6	V
VI	Input voltage	0 to 5.5	V
Vo	Output voltage (V _{CC} = 0 V)	0 to 5.5	V
V _O	Output voltage (high or low state)	0 to V _{CC}	V
I _{OH} , I _{OL}	High or low level output current ($V_{CC} = 3.0$ to 3.6 V)	±24	mA
I _{OH} , I _{OL}	High or low level output current ($V_{CC} = 2.7 V$)	±12	mA
dt/dv	Input rise and fall time ⁽²⁾	0 to 10	ns/V

1. Truth table guaranteed: 1.5 V to 3.6 V. $\,$

2. $V_{\rm IN}$ from 0.8 V to 2 V at $V_{\rm CC}$ = 3.0 V.



4 Electrical characteristics

Table 6.DC specifications

			est condition	Va	Value		
Symbol	Parameter	V _{CC}		-40 to	o 85 °C	Unit	
		(V)		Min.	Max.		
V _{IH}	High level input voltage	2.7 to 3.6		2.0		V	
V _{IL}	Low level input voltage	2.7 10 3.0			0.8	V	
		2.7 to 3.6	I _O = 100 μA		0.2		
V		2.7	I _O = 12 mA		0.4	V	
VOL	V _{OL} Low level output voltage	3.0	I _O = 16 mA		0.4		
		5.0	I _O = 24 mA		0.55		
I _I	Input leakage current	2.7 to 3.6	V _I = 0 to 5.5 V		±5	μA	
I _{off}	Power OFF leakage current	0	$V_{\rm I}$ or $V_{\rm O}$ = 5.5 V		10	μA	
I _{OZ}	High impedance output leakage current	2.7 to 3.6	$V_{I} = V_{IH} \text{ or } V_{IL}$ $V_{O} = 0 \text{ to } V_{CC}$		±5	μA	
			0.7 to 2.6	$V_{I} = V_{CC} \text{ or } GND$		10	
Icc	Quiescent supply current	2.7 to 3.6	$V_{\rm I}$ or $V_{\rm O}$ = 3.6 to 5.5 V		±10	μA	
ΔI_{CC}	I incr. per input	2.7 to 3.6	V _{IH} = V _{CC} - 0.6 V		500	μA	

Table 7. Dynamic switching characteristics

		Tes	Test condition		Value		
Symbol	Parameter	v _{cc}		Т	₄ = 25 °	Ő	Unit
		(V)		Min. Typ.	Тур.	Max.	
V _{OLP}	Dynamic low level quiet output ⁽¹⁾	2.2	V _{IL} = 0 V V _{IH} = 3.3 V		0.8		V
V _{OLV}		3.3	V _{IH} = 3.3 V		-0.8		v

1. Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the LOW state.



		Test condition Value						
Symbol	Parameter	v _{cc}	CL	RL	t _s = t _r	-40 to	85 °C	Unit - ns - ns
		(V)	(pF)	(Ω)	(ns)	Min.	Max.	
t	Propagation delay time	2.7	50	500	500 2.5		7.0	- ns
t _{PLZ}		3.0 to 3.6	50	500		1.0	5.2	
+	Propagation delay time	2.7	500	2.5		7.0		
t _{PZL}	Fropagation delay time	3.0 to 3.6	50	500	2.5	1.0	5.2	115
t _{OSLH} t _{OSHL}	Output to output skew time ⁽¹⁾ , ⁽²⁾	3.0 to 3.6	50	500	2.5		1.0	ns

Table 8. AC electrical characteristics

1. Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW ($t_{OSLH} = |t_{PLHm} - t_{PLHn}|$, $t_{OSHL} = |t_{PHLm} - t_{PHLn}|$).

2. Parameter guaranteed by design.

		Те	st condition		Value		
Symbol	Parameter	V _{cc}		٦	A = 25 °C		Unit
		(V)		Min.	Тур.	Max.	
C _{IN}	Input capacitance	3.3	$V_{IN} = 0$ to V_{CC}		6		pF
C _{OUT}	Output capacitance	3.3	$V_{IN} = 0$ to V_{CC}		14		pF
C _{PD}	Power dissipation capacitance ⁽¹⁾	3.3	f _{IN} = 10 MHz V _{IN} = 0 or V _{CC}		4.3		pF

1. C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to *Section 5: Test circuit*). Average operating current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/6$ (per gate).



5 Test circuit



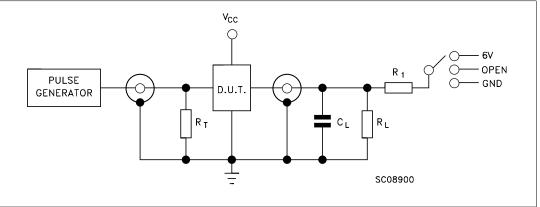


Table 10. Test circuit

Test	Switch
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	6 V
t _{PZH} , t _{PHZ}	GND

Note:

 $C_L = 50 \text{ pF}$ or equivalent (includes jig and probe capacitance)

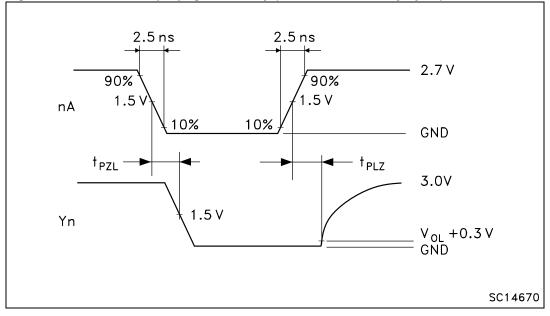
 $R_L = 500 \ \Omega$ or equivalent

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω).



6 Waveforms

74LCX07







7 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.

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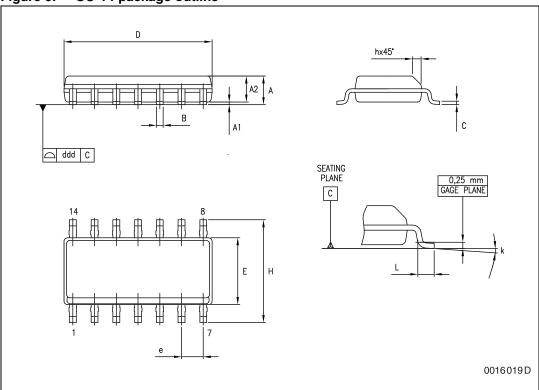


Table 11. SO-14 package mechanical data

	Dimensions						
Symbol	mm			inch			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А	1.35		1.75	0.053		0.069	
A1	0.1		0.25	0.004		0.010	
A2	1.10		1.65	0.043		0.065	
В	0.33		0.51	0.013		0.020	
С	0.19		0.25	0.007		0.010	
D	8.55		8.75	0.337		0.344	
Е	3.8		4.0	0.150		0.157	
е		1.27			0.050		
Н	5.8		6.2	0.228		0.244	
h	0.25		0.50	0.010		0.020	
L	0.4		1.27	0.016		0.050	
k	0°		8°	0°		8°	
ddd			0.100			0.004	



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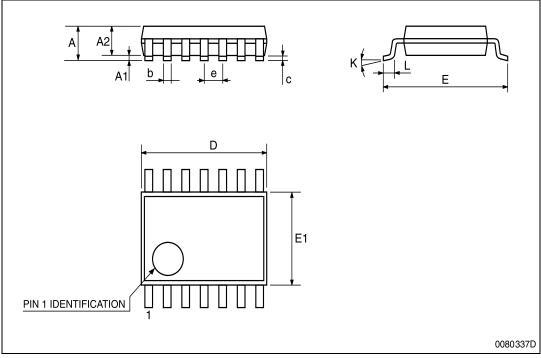


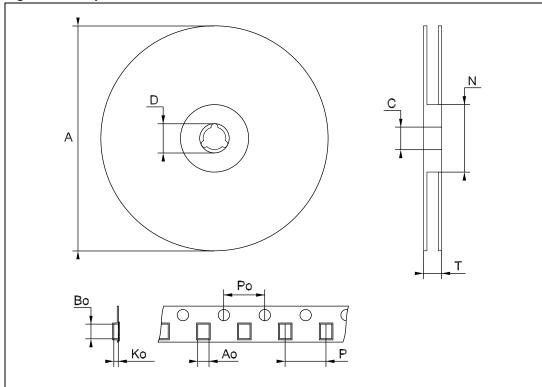
Figure 7. TSSOP14 package outline

Table 12. TSSOP14 package mechanical data

	Dimensions						
Symbol		mm			inch		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			1.2			0.047	
A1	0.05		0.15	0.002	0.004	0.006	
A2	0.8	1	1.05	0.031	0.039	0.041	
b	0.19		0.30	0.007		0.012	
С	0.09		0.20	0.004		0.0089	
D	4.9	5	5.1	0.193	0.197	0.201	
Е	6.2	6.4	6.6	0.244	0.252	0.260	
E1	4.3	4.4	4.48	0.169	0.173	0.176	
е		0.65 BSC			0.0256 BSC		
К	0°		8°	0°		8 °	
L	0.45	0.60	0.75	0.018	0.024	0.030	



Figure 8. Tape and reel SO-14 outline



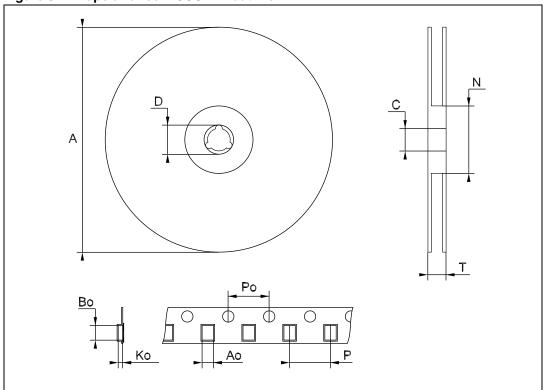
Drawing is not in scale.

	Dimensions						
Symbol		mm			inch		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			330			12.992	
С	12.8		13.2	0.504		0.519	
D	20.2			0.795			
Ν	60			2.362			
Т			22.4			0.882	
Ao	6.4		6.6	0.252		0.260	
Во	9		9.2	0.354		0.362	
Ко	2.1		2.3	0.082		0.090	
Po	3.9		4.1	0.153		0.161	
Р	7.9		8.1	0.311		0.319	

Table 13. Tape and reel SO-14 mechanical data







Drawing is not in scale.

	Dimensions						
Symbol	mm			inch			
	Min.	Тур.	Max.	Min.	Тур.	Max.	
А			330			12.992	
С	12.8		13.2	0.504		0.519	
D	20.2			0.795			
Ν	60			2.362			
Т			22.4			0.882	
Ao	6.7		6.9	0.264		0.272	
Во	5.3		5.5	0.209		0.217	
Ko	1.6		1.8	0.063		0.071	
Po	3.9		4.1	0.153		0.161	
Р	7.9		8.1	0.311		0.319	

Table 14. Tape and reel TSSOP14 mechanical data



8 Revision history

Table 15.	Document revision history
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Date	Revision	Changes		
15-Sep-2004	4	Ordering codes revision - pag. 1.		
10-Jul-2006	5	New template, temperature ranges updated		
20-Jun-2012	6	Added <i>Applications on page 1</i> Updated <i>Table 1: Device summary on page 1</i> Updated T _{op} in <i>Table 5: Recommended operating conditions</i> Updated ECOPACK [®] text in <i>Section 7: Package information</i> Minor textual updates		
21-Jun-2012	7	Updated Table 1: Device summary		
02-Oct-2012	8	Updated ESD performance in <i>Features</i> (updated HBM and MM, added CDM). Added 74LCX07YMTR device and "Marking" to <i>Table 1</i> , updated temperature range and note <i>1</i> . Updated <i>Section 3: Maximum ratings</i> (added cross-references). Removed "Operating temperature" from <i>Table 5</i> . Reformatted <i>Section 7: Package information</i> . Minor corrections throughout document.		



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